TRANSFER-MOLD TYPE INSULATED TYPE

### PS21963-S



#### INTEGRATED POWER FUNCTIONS

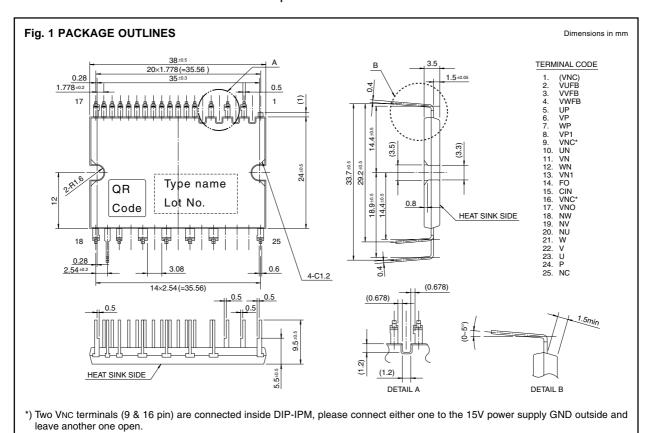
600V/10A low-loss  $5^{th}$  generation IGBT inverter bridge for three phase DC-to-AC power conversion. Open emitter type.

### INTEGRATED DRIVE, PROTECTION AND SYSTEM CONTROL FUNCTIONS

- For upper-leg IGBTs: Drive circuit, High voltage isolated high-speed level shifting, Control supply under-voltage (UV) protection.
- For lower-leg IGBTs: Drive circuit, Control supply under-voltage protection (UV), Short circuit protection (SC).
- Fault signaling: Corresponding to an SC fault (Lower-leg IGBT) or a UV fault (Lower-side supply).
- Input interface: 3V, 5V line (High Active).

## **APPLICATION**

AC100V~200V inverter drive for small power motor control.





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## **MAXIMUM RATINGS** ( $T_j = 25^{\circ}C$ , unless otherwise noted)

### **INVERTER PART**

Symbol	Parameter	Condition	Ratings	Unit
Vcc	Supply voltage	Applied between P-NU, NV, NW	450	V
VCC(surge)	Supply voltage (surge)	Applied between P-NU, NV, NW	500	V
VCES	Collector-emitter voltage		600	V
±lc	Each IGBT collector current	Tc = 25°C	10	Α
±ICP	Each IGBT collector current (peak)	Tc = 25°C, less than 1ms	20	Α
Pc	Collector dissipation	Tc = 25°C, per 1 chip	27.0	W
Tj	Junction temperature	(Note 1)	-20~+125	°C

Note 1: The maximum junction temperature rating of the power chips integrated within the DIP-IPM is  $150^{\circ}$ C (@ Tc  $\leq 100^{\circ}$ C). However, to ensure safe operation of the DIP-IPM, the average junction temperature should be limited to  $T_{j(ave)} \leq 125^{\circ}$ C (@ Tc  $\leq 100^{\circ}$ C).

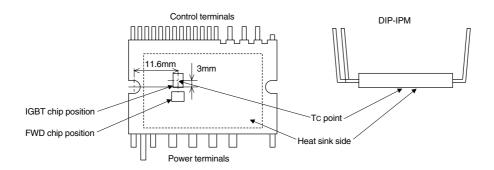
## **CONTROL (PROTECTION) PART**

Symbol	Parameter	Condition	Ratings	Unit
VD	Control supply voltage	Applied between VP1-VNC, VN1-VNC 20		V
VDB	Control supply voltage	Applied between Vufb-U, Vvfb-V, Vwfb-W	20	V
VIN	Input voltage	Applied between UP, VP, WP, UN, VN, WN-VNC	-0.5~VD+0.5	V
VFO	Fault output supply voltage	Applied between Fo-VNC	-0.5~VD+0.5	V
IFO	Fault output current	Sink current at Fo terminal	1	mA
Vsc	Current sensing input voltage	Applied between CIN-VNC	-0.5~VD+0.5	V

### **TOTAL SYSTEM**

Symbol	Parameter	Condition	Ratings	Unit
VCC(PROT)	Self protection supply voltage limit (short circuit protection capability)	$VD = 13.5 \sim 16.5 \text{V}$ , Inverter part $T_j = 125 ^{\circ}\text{C}$ , non-repetitive, less than 2μs	400	V
Tc	Module case operation temperature	(Note 2)	-20~+100	°C
Tstg	Storage temperature		<b>−</b> 40~+125	ŷ
Viso	Isolation voltage	60Hz, Sinusoidal, 1 minute, All connected pins to heat-sink plate	1500	Vrms

Note 2: To measurement point





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### THERMAL RESISTANCE

Cumphal	Davamatav	Condition	Limits			Limit
Symbol	Parameter	Condition		Тур.	Max.	Unit
Rth(j-c)Q	Junction to case thermal Inverter IGBT part (per 1/6 module)		_	_	3.7	°C/W
Rth(j-c)F	resistance (Note 3)	Inverter FWD part (per 1/6 module)	-	_	4.5	°C/W

Note 3: Grease with good thermal conductivity should be applied evenly with about +100µm~+200µm on the contacting surface of DIP-IPM

and heat-sink.

The contacting thermal resistance between DIP-IPM case and heat sink (Rth(c-f)) is determined by the thickness and the thermal conductivity of the applied grease. For reference, Rth(c-f) (per 1/6 module) is about 0.3°C/W when the grease thickness is 20μm and the thermal conductivity is 1.0W/m-k.

## **ELECTRICAL CHARACTERISTICS** (Tj = 25°C, unless otherwise noted)

#### **INVERTER PART**

Symbol Parameter		Condition		Limits			Unit	
Symbol	Parameter	Condition		Min.	Тур.	Max.	Offic	
VCE(sat) Collector-emitter saturation		VD = VDB = 15V	Ic = 10A, Tj = 25°C	_	1.70	2.20	.,	
VCE(Sai)	voltage	VIN = 5V	Ic = 10A, Tj = 125°C	_	1.80	2.30	V	
VEC	FWD forward voltage	Tj = 25°C, -IC = 10A, VIN = 0V		_	1.70	2.20	V	
ton				0.60	1.10	1.70	μs	
trr		VCC = 300V, VD = VDB = 15V			0.30	_	μs	
tc(on)	Switching times	IC = 10A, T <sub>j</sub> = 125°C, VIN = 0 $\leftrightarrow$ 5V Inductive load (upper-lower arm)		_	0.40	0.60	μs	
toff				_	1.50	2.10	μs	
tc(off)				_	0.50	0.80	μs	
ICES	Collector-emitter cut-off	VCF = VCFS	Tj = 25°C	_	_	1	mA	
	current	VUE = VUES	Tj = 125°C	_	_	10		

### **CONTROL (PROTECTION) PART**

Cumbal	Parameter	Condition			Limits			Unit	
Symbol	Parameter				Min.	Тур.	Max.	Offit	
		VD = VDB = 15V Total of VP1-VNC, VN1-VNC		_	_	2.80			
lo.	Circuit current	VIN = 5V	Vufb-	·U, Vvfb-V, Vwfb-W	_	_	0.55		
ID	Circuit current	VD = VDB = 15V	Total of	of VP1-VNC, VN1-VNC	_	_	2.80	mA	
		VIN = 0V	Vufb-	·U, Vvfb-V, Vwfb-W	_	_	0.55	55	
VFOH	Fault output voltage	Vsc = 0V, Fo terminal pull-up to 5V by $10k\Omega$			4.9	_		V	
VFOL	Fault output voltage	VSC = 1V, IFO = 1mA			_	_	0.95	V	
VSC(ref)	Short circuit trip level	$T_j = 25^{\circ}C, VD = 15V$ (Note 4)			0.43	0.48	0.53	V	
lin	Input current	VIN = 5V			0.70	1.00	1.50	mΑ	
UVDBt			Trip level	Trip level	10.0	_	12.0	V	
UVDBr	Control supply under-voltage	   T <sub>i</sub> ≤ 125°C		Reset level	10.5	_	12.5	V	
UVDt	protection	1] ≤ 125 C	Trip level	10.3	_	12.5	V		
UVDr				Reset level	10.8	_	13.0	V	
tFO	Fault output pulse width		(Note 5)			_		μs	
Vth(on)	ON threshold voltage				_	2.1	2.6	V	
Vth(off)	OFF threshold voltage	Applied between LID VID WID LIN VAL WALVALO		0.8	1.3		V		
Vth(hys)	ON/OFF threshold hysteresis voltage	Applied between UP, VP, WP, UN, VN, WN-VNC			0.35	0.65		V	

Note 4: Short circuit protection is functioning only for the lower-arms. Please select the external shunt resistance such that the SC trip-level is less than 1.7 times of the current rating.

5: Fault signal is asserted corresponding to a short circuit or lower side control supply under-voltage failure.



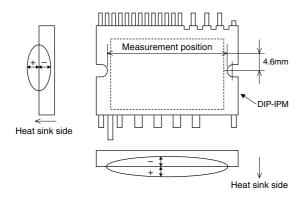
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### **MECHANICAL CHARACTERISTICS AND RATINGS**

Dovometer	Condition		Limits			Llmit
Parameter	Con	Min.	Тур.	Max.	Unit	
Mounting torque	Mounting screw : M3 (Note 6) Recommended : 0.69 N·m		0.59	_	0.78	N⋅m
Weight			_	10	_	g
Heat-sink flatness		(Note 7)	-50	_	100	μm

Note 6: Plain washers (ISO 7089~7094) are recommended.

Note 7: Flatness measurement position



### **RECOMMENDED OPERATION CONDITIONS**

Cumahal	Parameter Condition		Reco	Recommended value		Unit	
Symbol Parameter		Condition		Min.	Тур.	Max.	Unit
Vcc	Supply voltage	Applied between P-NU, NV, NW		0	300	400	V
VD	Control supply voltage	Applied between VP1-VNC, VN1-VNC		13.5	15.0	16.5	V
VDB	Control supply voltage	Applied between VUFB-U, VVFB-V, VWFB-V	N	13.0	15.0	18.5	V
$\Delta V$ D, $\Delta V$ DB	Control supply variation				_	1	V/μs
tdead	Arm shoot-through blocking time	For each input signal, Tc ≤ 100°C			_	_	μs
	A.I	Vcc = 300V, VD = VDB = 15V,	fpwm = 5kHz	_	_	5.0	
lo	Allowable r.m.s. current	$ \begin{array}{l} \text{P.F} = 0.8, \text{ sinusoidal output,} \\ \text{T}_{\text{j}} \leq 125^{\circ}\text{C}, \text{Tc} \leq 100^{\circ}\text{C} \end{array} \tag{Note 8} $	fPWM = 15kHz	_	_	3.0	Arms
PWIN(on)	Allowable minimum input		0.5	_	_		
PWIN(off)	pulse width		0.5	_	_	μs	
Vnc	VNC variation	Between VNC-NU, NV, NW (including sur	ge)	-5.0	_	5.0	V

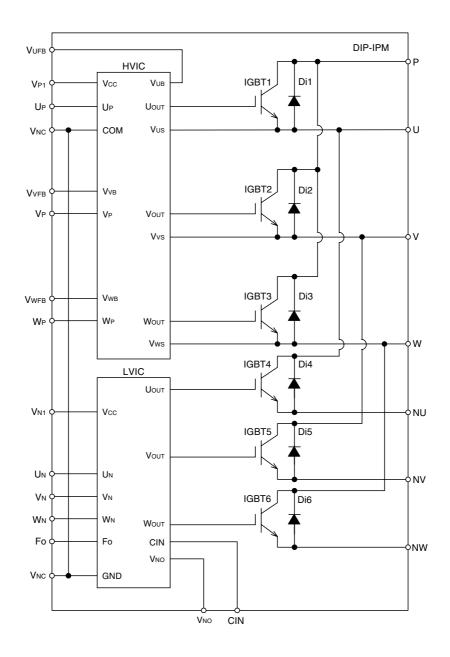
Note 8: The allowable r.m.s. current value depends on the actual application conditions.



<sup>9:</sup> IPM might not make response if the input signal pulse width is less than the recommended minimum value.

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Fig. 2 THE DIP-IPM INTERNAL CIRCUIT



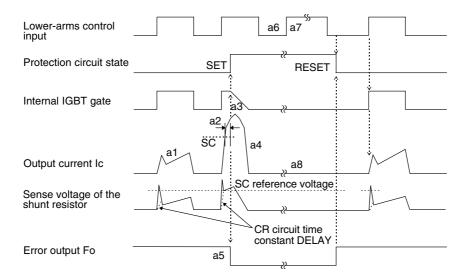


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### Fig. 3 TIMING CHART OF THE DIP-IPM PROTECTIVE FUNCTIONS

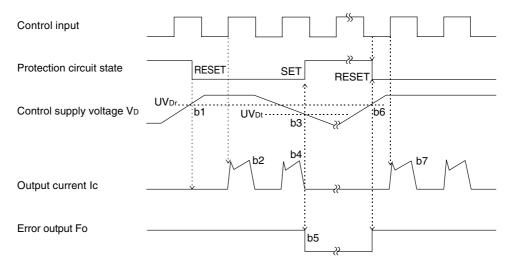
#### [A] Short-Circuit Protection (Lower-arms only with the external shunt resistor and CR filter)

- a1. Normal operation: IGBT ON and carrying current.
- a2. Short circuit detection (SC trigger).
- a3. IGBT gate hard interruption.
- a4. IGBT turns OFF.
- a5. Fo output (tFO(min) =  $20\mu$ s).
- a6. Input "L" : IGBT OFF.
- a7. Input "H": IGBT ON.
- a8. IGBT OFF in spite of input "H".



### [B] Under-Voltage Protection (Lower-arm, UVD)

- b1. Control supply voltage rises : After the voltage level reaches UVDr, the circuits start to operate when next input is applied. b2. Normal operation : IGBT ON and carrying current.
- b3. Under voltage trip (UVDt).
- b4. IGBT OFF in spite of control input condition.
- b5. Fo output (tFo ≥ 20μs and Fo output continuously during UV period). b6. Under voltage reset (UVDr).
- b7. Normal operation: IGBT ON and carrying current.





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### [C] Under-Voltage Protection (Upper-arm, UVDB)

- c1. Control supply voltage rises: After the voltage reaches UVDBr, the circuits start to operate when next input is applied. c2. Normal operation: IGBT ON and carrying current.
- c3. Under voltage trip (UVDBt).
- c4. IGBT OFF in spite of control input signal level, but there is no Fo signal output.
- c5. Under voltage reset (UVDBr).
- c6. Normal operation: IGBT ON and carrying current.

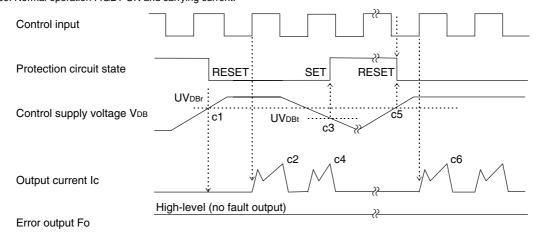
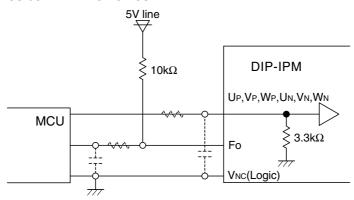


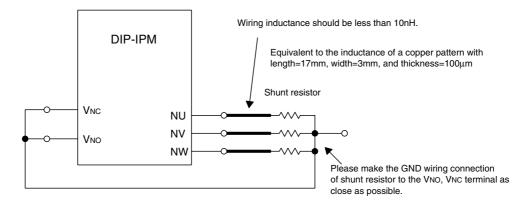
Fig. 4 RECOMMENDED MCU I/O INTERFACE CIRCUIT



Note: The setting of RC coupling at each input (parts shown dotted) depends on the PWM control scheme and the wiring impedance of the printed circuit board.

The DIP-IPM input section integrates a  $3.3k\Omega$  (min) pull-down resistor. Therefore, when using an external filtering resistor, pay attention to the turn-on threshold voltage.

Fig. 5 WIRING CONNECTION OF SHUNT RESISTOR

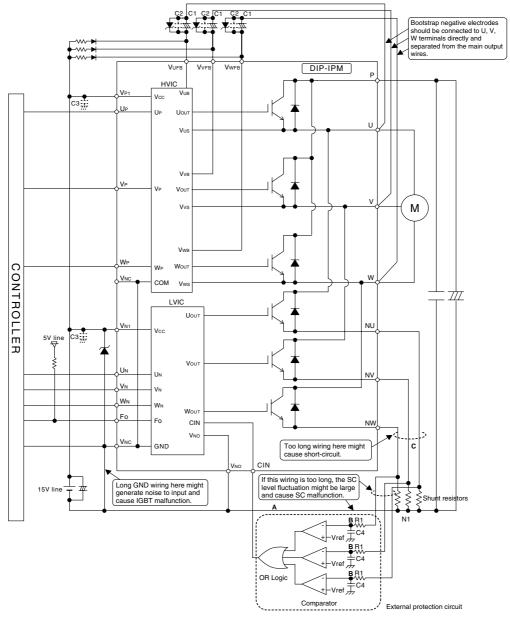




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### Fig. 6 TYPICAL DIP-IPM APPLICATION CIRCUIT EXAMPLE

C1:Tight tolerance temp-compensated electrolytic type C2,C3: 0.22~2µF R-category ceramic capacitor for noise filtering



- Note 1 : To prevent malfunction, the wiring of each input should be as short as possible (2~3cm).
  - 2 : By virtue of integrating HVIC inside, direct coupling to MCU without opto-coupler or transformer isolation is possible.
    - 3 : Fo output is open drain type. It should be pulled up to a 5V supply with an approximately  $10k\Omega$  resistor.
  - 4 : The logic of input signal is high-active. The DIP-IPM input signal section integrates a 3.3kΩ (min) pull-down resistor. If using external filtering resistor, ensure the voltage drop of ON signal not below the threshold value.
  - 5 : To prevent malfunction of protection, the wiring of A, B, C should be as short as possible.
  - Flease set the filter R1•C4 time constant such that the IGBT can be interrupted within 2μs.
  - 7 : Each capacitor should be located as nearby the pins of the DIP-IPM as possible.
  - 8 :To prevent surge destruction, the wiring between the smoothing capacitor and the P-N1 pins should be as short as possible. Approximately a 0.1~0.22μF snubber capacitor between the P-N1 pins is recommended.
  - 9 : Make external wiring connection between VNO and VNC terminals as shown in Fig.5.
  - 10 : Two VNc terminals (9 & 16 pin) are connected inside DIP-IPM, please connect either one to the 15V power supply GND outside and leave another one open.
  - 11 : To prevent ICs from surge destruction, it is recommended to insert a Zener diode (24V, 1W) between each control supply terminals.
  - 12 : The reference voltage Vref of comparator should be set up the same rating of short circuit trip level (Vsc(ref): min.0.43V to max.0.53V).
  - 13: OR logic output level should be set up the same rating of short circuit trip level (Vsc(ref): min.0.43V to max.0.53V).

